

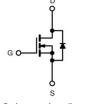
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N-channel Power MOSFET

PRODUCT SUMMARY

V _{DS} (V) at T _J max.	700			
$R_{DS(on)}$ max. at 25°C (Ω)	V _{GS} =10V	1.1		
Q _g max. (nC)	4	5		
Q _{gs} (nC)	-	7		
Q _{gd} (nC)	1	5		
Configuration	sin	gle		





TO-220F

Schematic diagram

Features

- ID=10A(Vgs=10V)
- Ultra Low Gate Charge
- Improved dv/dt Capability
- 100% Avalanche Tested
- RoHS compliant

Applications

- Switching Mode Power Supplies (SMPS)
- PWM Motor Controls
- DC to DC Converters
- LED Lighting
- Bridge Circuits

ORDERINGINFORMATION				
Device	SPC10N65G			
Device Package	TO-220F			
Marking	10N65G			

ABSOLUTE MAXIMUM RATINGS (Tc = 25°C, unless otherwise noted)					
Parameter	Symbol	Limit	Unit		
Drain to Source Voltage	V _{DSS}	650	V		
Continuous Drain Current (@Tc=25°C)		10 (1)	Α		
Continuous Drain Current (@Tc=100°C)	I _D	6.0 (1)	Α		
Drain current pulsed ⁽²⁾	I _{DM}	40 (1)	Α		
Gate to Source Voltage	V _{GS}	±30	V		
Single pulsed Avalanche Energy ⁽³⁾	E _{AS}	400	mJ		
Peak diode Recovery dv/dt ⁽⁴⁾	dv/dt	6	V/ns		
Total power dissipation (@Tc=25°C)	P	40	W		
Derating Factor above 25°C	- P _D -	0.32	W/ºC		
Operating Junction Temperature & Storage Temperature	T _{STG} , T _J	-55 to + 150	°C		
Maximum lead temperature for soldering purpose	TL	260	°C		
Mounting torque ⁽⁵⁾		0.4~0.6	N.m		

Notes

1. Drain current is limited by maximum junction temperature.

2. Repetitive rating : pulse width limited by junction temperature.

- 3. L = 8mH, I_{AS} = 10A, V_{DD} = 50V, R_G=25\Omega, Starting at T_J = 25°C
- 4. $I_{SD} \leq$ 10A, di/dt = 100A/us, $V_{DD} \leq BV_{DSS},$ Starting at T_{J} =25°C

5. Mounting consideration for TO220 Fullpack:

M3 screw plus flat washer is suggested, free of burr between devices and contact area,

the devices are to be mounted to a hole not larger than 3.6mm in contact diameter (chamfer included).

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THERMAL CHARACTERISTICS					
Parameter	Symbol	Value	Unit		
Thermal resistance, Junction to case	R _{thjc}	3.1	°C/W		
Thermal resistance, Junction to ambient	R _{thja}	48	°C/W		

ELECTRICAL CHARACTERISTICS ($T_c = 25^{\circ}C$ unless otherwise specified)						
Parameter	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Off Characteristics						
Drain to source breakdown voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	650			V
Breakdown voltage temperature coefficient	ΔBV _{DSS} / ΔTJ	I _D =250uA, referenced to 25°C		0.51		V/⁰C
		V _{DS} =650V, V _{GS} =0V			1	uA
Drain to source leakage current	DSS	V _{DS} =520V, T _C =125°C			50	uA
Gate to source leakage current, forward	Igss	V _{GS} =30V, V _{DS} =0V			100	nA
Gate to source leakage current, reverse	IGSS	V _{GS} =-30V, V _{DS} =0V			-100	nA
On Characteristics						
Gate threshold voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250uA	2		4	V
Drain to source on state resistance	R _{DS(ON)}	V _{GS} =10V, I _D =5A		0.85	1.1	Ω
Forward Transconductance	Gfs	V _{DS} = 30 V, I _D = 5A		7		S
Dynamic Characteristics						
Input capacitance	Ciss			1200		
Output capacitance	Coss	V_{GS} =0V, V_{DS} =25V, f=1MHz		125		pF
Reverse transfer capacitance	C _{rss}			21		
Turn on delay time	t _{d(on)}			15		
Rising time	tr	V_{DS} =380V, I_{D} =10A , R_{G} =25 Ω		45		ns
Turn off delay time	$t_{d(off)}$			90		115
Falltime	t _f			30		
Total gate charge	Qg			38		
Gate-source charge	Q _{gs}	V _{DS} =520V, V _{GS} =10V, I _D =10A		7		nC
Gate-drain charge	Q_gd			15		

SOURCE TO DRAIN DIODE RATINGS CHARACTERISTICS						
Parameter	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Continuous source current	ls	Integral reverse p-n Junction _ diode in the MOSFET			10	А
Pulsed source current	I _{SM}				40	А
Diode forward voltage drop.	V _{SD}	I _S =10A, V _{GS} =0V			1.2	V
Reverse recovery time	T _{rr}	I _S =10A, V _{GS} =0V, dI _F /dt=100A/us		502		ns
Reverse recovery Charge	Qrr			13		uC

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SPC10N65G

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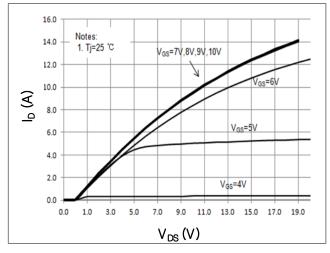
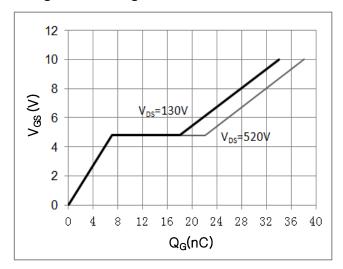


Fig1. Output characteristics

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Fig3. Gate charge characteristics





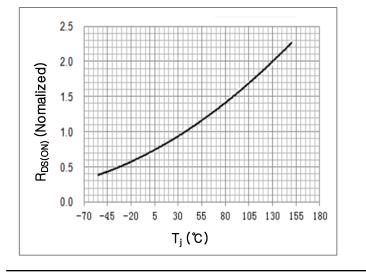


Fig2. Drain-source on-state resistance

Fig 4. Capacitance Characteristics

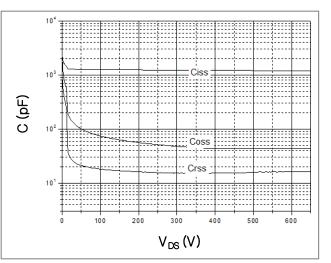
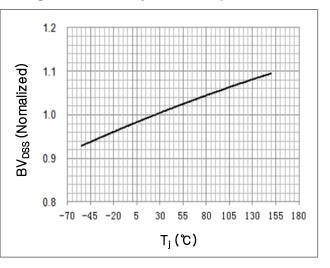


Fig 6. BVDss vs junction temperature



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Fig 7 . Safe operating area

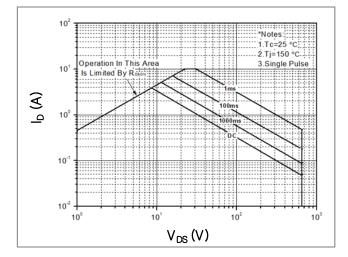


Fig 9. Forward characteristics of reverse diode

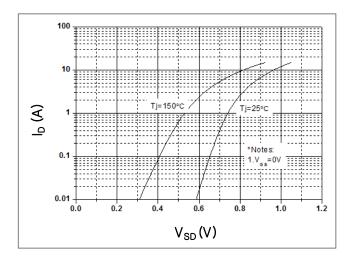


Fig 10. Gate charge test circuit & waveform

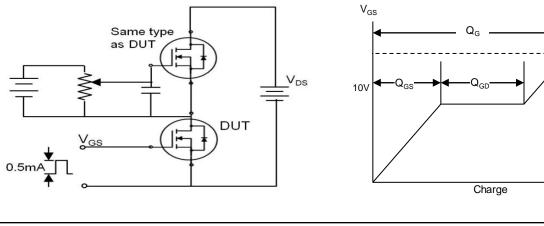
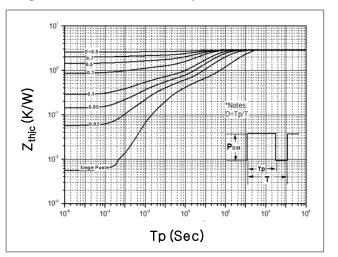


Fig 8. Transient thermal impedance



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Fig 11. Switching time test circuit & waveform

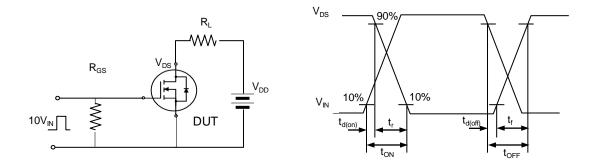


Fig 12. Unclamped Inductive switching test circuit & waveform

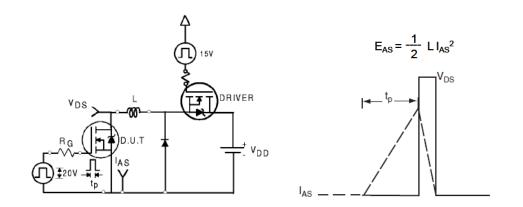
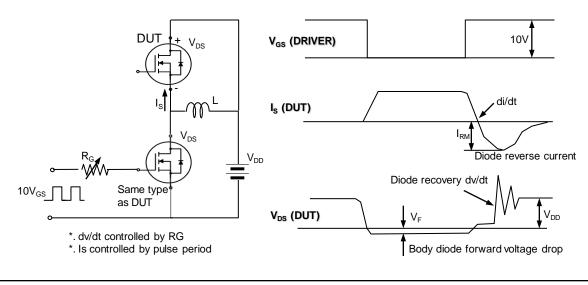


Fig 13. Peak diode recovery dv/dt test circuit & waveform



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